Preferred Devices

NPN Silicon Power Transistors High Voltage Planar

The MJW18020 planar High Voltage Power Transistor is specifically Designed for motor control applications, high power supplies and UPS's for which the high reproducibility of DC and Switching parameters minimizes the dead time in bridge configurations.

Mains features include:

- High and Excellent Gain Linearity
- Fast and Very Tight Switching Times Parameters t_{si} and t_{fi}
- Very Stable Leakage Current due to the Planar Structure
- High Reliability



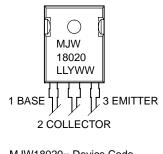
ON Semiconductor"

http://onsemi.com

30 AMPERES 1000 VOLTS BV_{CES} 450 VOLTS BV_{CEO} 250 WATTS



MARKING DIAGRAM



MJW180	J20= Device Code
LL	= Location Code
Y	= Year
WW	= Work Week

ORDERING INFORMATION

Device	Package	Shipping
MJW18020	TO–247	30 Units/Rail

1. Pulse Test: Pulse Width = 5 μ s, Duty Cycle \leq 10%.

Preferred devices are recommended choices for future use and best overall value.



Rating	Symbol	Value	Unit
Collector–Emitter Sustaining Voltage	V _{CEO}	450	Vdc
Collector–Base Breakdown Voltage	V _{CES}	1000	Vdc
Collector-Base Voltage	V _{CBO}	1000	Vdc
Emitter-Base Voltage	V _{EBO}	9.0	Vdc
Collector Current – Continuous – Peak (Note 1.)	Ι _C	30 45	Adc
Base Current – Continuous – Peak (Note 1.)	Ι _Β	6.0 10	Adc
Total Power Dissipation @ T _C = 25°C Derate Above 25°C	PD	250 2.0	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	–65 to +150	°C

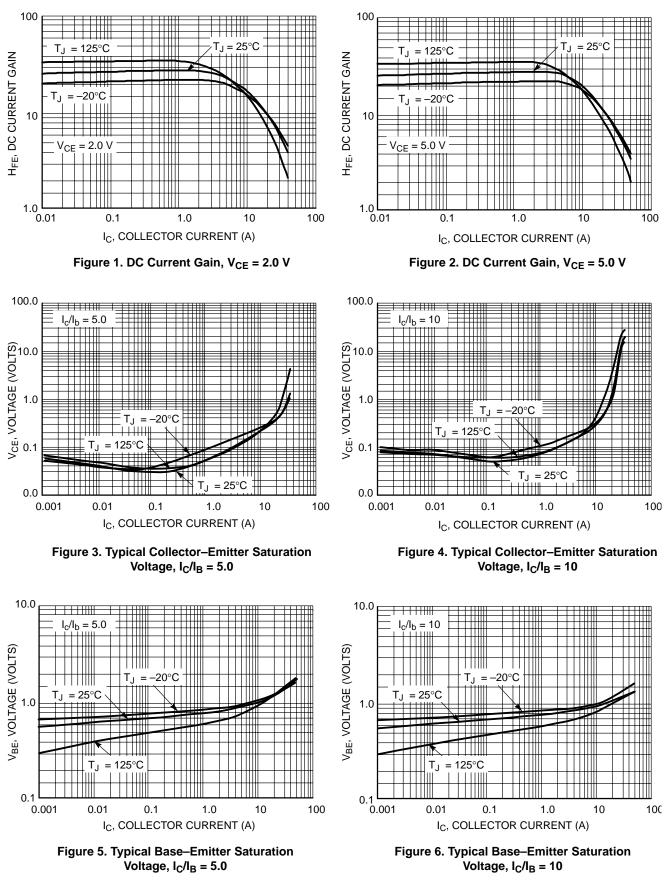
THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit		
Thermal Resistance, Junction–to–Case	$R_{ extsf{ heta}JC}$	0.5	°C/W		
Thermal Resistance, Junction–to–Ambient	$R_{ heta JA}$	50	°C/W		
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	TL	275	°C		

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS	I				1
Collector–Emitter Sustaining Voltage $(I_C = 100 \text{ mAdc}, I_B = 0)$	V _{CEO(sus)}	450	-	-	Vdc
Collector Cutoff Current (V_{CE} = Rated V_{CEO} , I_B = 0)	I _{CEO}	-	-	100	μAdc
Collector Cutoff Current (V_{CE} = Rated V_{CES} , V_{EB} = 0) (T	_C = 125°C)	-	-	100 500	μAdc
Emitter Cutoff Current ($V_{CE} = 9 Vdc$, $I_C = 0$)	I _{EBO}	-	-	100	μAdc
N CHARACTERISTICS					
$(I_{C} = 10 \text{ Adc } V_{CE} = 2 \text{ Vdc})$ $(I_{C} = 20 \text{ Adc } V_{CE} = 2 \text{ Vdc})$	h_{FE} $c = 125^{\circ}C)$ $c = 125^{\circ}C)$ $c = 125^{\circ}C)$	14 - 8 5 5.5 4	30 16 14 9 7	34 - - -	
$(I_{C} = 10 \text{ mAdc } V_{CE} = 5 \text{ Vdc})$		14	25	_	
Base–Emitter Saturation Voltage $(I_C = 10 \text{ Adc}, I_B = 2 \text{ Adc})$ $(I_C = 20 \text{ Adc}, I_B = 4 \text{ Adc})$	V _{BE(sat)}	-	0.97 1.15	1.25 1.5	Vdc
$(I_C = 20 \text{ Adc}, I_B = 4 \text{ Adc})$	$V_{CE(sat)}$ $C = 125^{\circ}C)$ $C = 125^{\circ}C)$	- - - -	0.2 0.3 0.5 0.9	0.6 - 1.5 2.0	Vdc
	, , , , , , , , , , , , , , , , , , ,				
Current Gain Bandwidth Product ($I_C = 1 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 1 \text{ MHz}$)	f _T	-	13	_	MHz
Output Capacitance ($V_{CB} = 10 \text{ Vdc}, I_E = 0, f_{test} = 1 \text{ MHz}$)	C _{ob}	-	300	500	pF
Input Capacitance (V _{EB} = 8.0)	C _{ib}	-	7000	9000	pF
SWITCHING CHARACTERISTICS: Resistive Load (D.C. = 1	0%, Pulse Width = 70 μs)				
Turn–On Time $(I_C = 10 \text{ Adc}, I_{B1} = I_{B2} \text{ Vcc} = 125 \text{ V})$	= 2 Adc, t _{On}	-	540	750	ns
Storage Time	t _s	_	4.75	6	μs
Fall Time	t _f	_	380	500	ns
Turn–Off Time	t _{Off}	_	5.2	6.5	μs
$\label{eq:linear} \mbox{Iurn-On Time} \qquad (I_C=20 \mbox{ Adc}, I_{B1}=I_{B2})$		_	965	1200	ns
Storage Time Vcc = 125 V)	t _s	_	2.9	3.5	μs
Fall Time	t _f	-	350	500	ns
Turn–Off Time	t _{Off}	_	3.25	4	μs
SWITCHING CHARACTERISTICS: Inductive Load (V _{clamp} =		200 μH)			
Fall Time $(I_C = 10 \text{ Adc}, I_{B1} = I_{B2})$	= 2 Adc) t _{fi}	_	142	250	ns
Storage Time	t _{si}	_	4.75	6	μs
Crossover Time	t _C	-	320	500	ns
Fall Time $(I_C = 20 \text{ Adc}, I_{B1} = I_{B2})$		_	350	500	ns
Storage Time	t _{si}	_	3.0	3.5	μs
			1		





TYPICAL CHARACTERISTICS

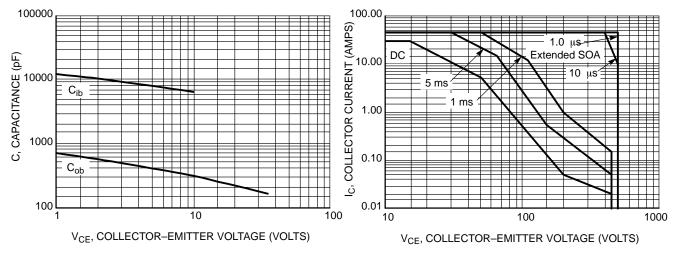


Figure 7. Typical Capacitance

Figure 8. Forward Bias Safe Operating Area

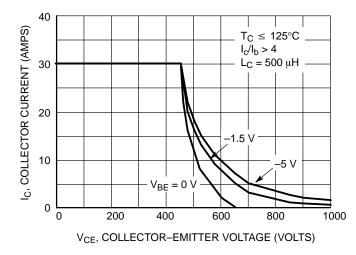
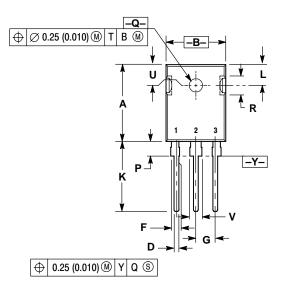
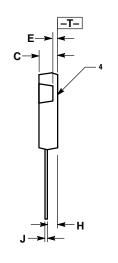


Figure 9. Reverse Bias Safe Operating Area

PACKAGE DIMENSIONS







NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	19.7	20.3	0.776	0.799
В	15.3	15.9	0.602	0.626
С	4.7	5.3	0.185	0.209
D	1.0	1.4	0.039	0.055
E	1.27 REF		0.050 REF	
F	2.0	2.4	0.079	0.094
G	5.5 BSC		0.216	BSC
Н	2.2	2.6	0.087	0.102
J	0.4	0.8	0.016	0.031
K	14.2	14.8	0.559	0.583
L	5.51	MON	0.217	NOM
Р	3.7	4.3	0.146	0.169
Q	3.55	3.65	0.140	0.144
R	5.0 NOM		0.197	NOM
U	5.5	5.5 BSC		' BSC
V	3.0	3.4	0.118	0.134

STYLE 3: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

<u>Notes</u>

<u>Notes</u>

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